

RFVC1821 LOW NOISE MMIC VCO WITH BUFFER AMPLIFIER

Package: QFN, 24 pin, 4mm x 4mm



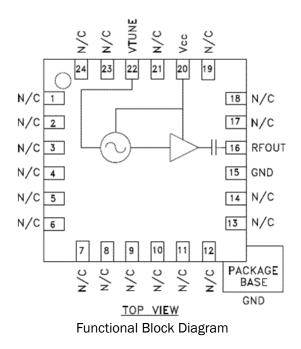


Features

- 4.45 GHz to 5.2 GHz Operation
- -108dBc/Hz Phase Noise at 100KHz Offset
- +8.0dBm P_{OUT}
- No External Resonator or Elements Needed
- 4mmx4mm QFN Package
- 3V V_{CC} Operation

Applications

- Instrumentation
- Military
- Aerospace
- Point-to-Point Radio
- Test Equipment
- VSAT
- CATV



Product Description

RFMD's RFVC1821 is a 3V InGaP MMIC VCO with an integrated buffer amplifier operating over a frequency range of 4.45GHz to 5.2GHz. Its monolithic tuning structure provides excellent temperature, shock, and vibration performance while its integrated buffer amplifier provides an output power of +8dBm from a 3V supply. Phase noise is -108dBc/Hz at 100kHz offset. The RFVC1821 is available in a low cost leadless ceramic 4mmx4mm surface mount QFN outline.

Ordering Information

-	
RFVC1821S2	2 piece sample bag
RFVC1821PCK-410	PCBA with 2 piece sample bag
RFVC1821SB	5 piece bag
RFVC1821SQ	25 piece bag
RFVC1821SR	100 pieces on 7" reel
RFVC1821TR7	750 pieces on 7"reel

1) B32-678-5570 or customerspryice@rfmd.

Optimum Technology Matching® Applied

 □ GaAs HBT
 □ SiGe BiCMOS

 □ GaAs MESFET
 □ Si BiCMOS

 ☑ InGaP HBT
 □ SiGe HBT

□ GaAs pHEMT □ GaN HEMT □ Si CMOS □ BIFET HBT □ Si BJT □ LDMOS

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RFVC1821



Absolute Maximum Ratings

Parameter	Rating	Unit			
Bias Voltage (V _{DD})	+3.25	V _{DC}			
V _{TUNE}	15	V _{DC}			
Operating Junction Temperature (T _J)	99	°C			
Continuous Power Dissipation (T=+85°C)	185	mW			
Thermal Resistance (Pad to Die Bottom)	10	°C/W			
Storage Temperature	-40 to +150	°C			
Operating Temperature	-40 to +85°C	°C			
ESD JESD22-A114 Human Body Model (HBM)	Class 0, 150V				



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

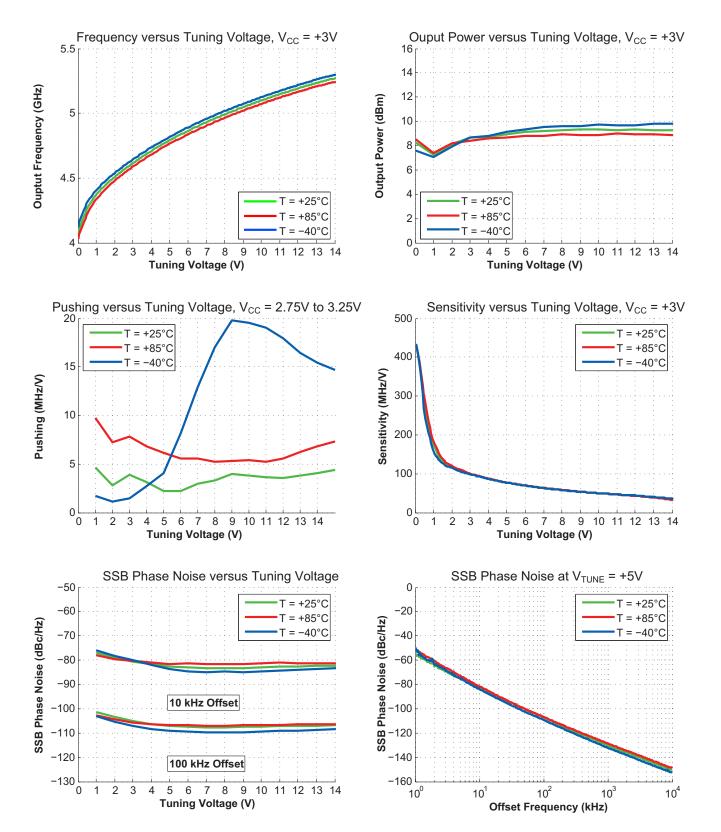
RoHS status based on EUDirective 2002/95/EC (at time of this document revision).

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Parameter	Specification		Unit	Condition		
Farameter	Min.	Тур.	Max.	Max.	Condition	
Electrical Specifications					T _A =+25 °C, V _{CC} =+3.0V _{DC}	
Operating Frequency	4.45		5.2	GHz		
V _{TUNE}	1.5		14.5	V		
V _{TUNE} Leakage Current		0.3	1.0	uA	At V _{TUNE} =10V	
Output Power	5	8		dBm	At V _{TUNE} =5V	
Phase Noise at 10kHz Offset		-84		dBc/Hz	At V _{TUNE} =5V	
Phase Noise at 100 kHz Offset		-108		dBc/Hz	At V _{TUNE} =5V	
Harmonics						
2nd		-14		dBc	At V _{TUNE} =5V	
3rd		-37		dBc		
Output Spurious			-70	dBc		
Output Return Loss		10		dB		
Supply Current		43	50	mA	At V _{TUNE} =5V	
Pulling		5.5		MHz	VSWR 2.5:1 all phases	
Pushing		2.2		MHz/V	At V _{TUNE} =5V	
Frequency Drift		-0.36		MHz/C	At V _{TUNE} =5V	







Typical Electrical Performance

RFVC1821



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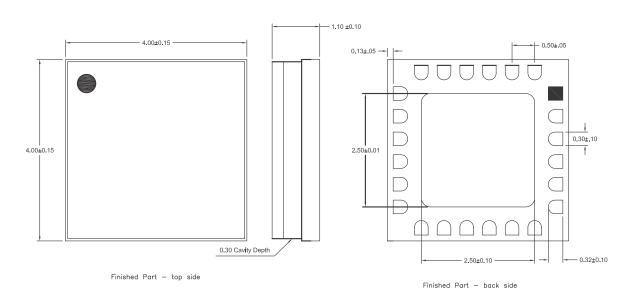
Pin	Function	Description	Interface Schematic
15	GND	Connect directly to PCB ground for best performance.	
16	RFOUT	RF out. This pad is AC coupled and matched for optimum P_{OUT} . A 50 Ω termination is recommended for this pin.	
20	VCC	Connect 3V to power both the oscillator core and the buffer amplifier.	
22	VTUNE	Direct connection to the varactor diodes used to vary the frequency of oscillation.	
Pkg Base	GND	Ground connection. Solder package bottom directly to ground plane for best performance.	

Note: All dimensions in millimeters.





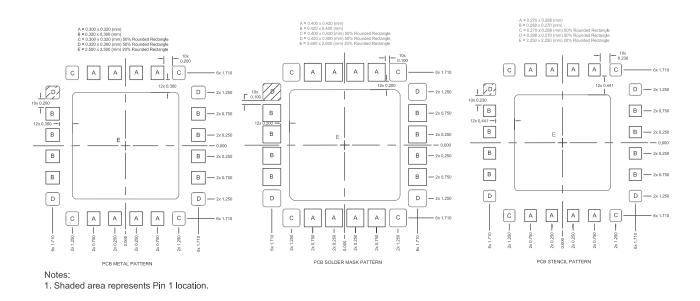
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Package Drawing

- 1. Dimensions in mm.
- 2. Dimensions are for reference only.
- 3. Package body material: Alumina.
- 4. Lead and paddle plating: Au, 30u" minimum.

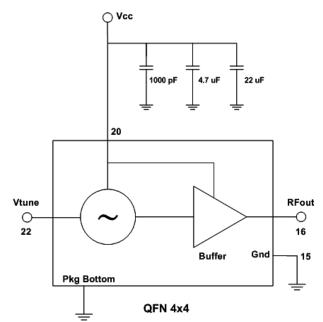
Recommended PCB Layout



1) 836-678-5570 or customers ryice@rfmd.

m.





Application Circuit Block Diagram

Evaluation Board Layout

